

1A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER
FEATURES:

- Glass Passivated Chip Junction
- Reverse Voltage - 100 to 1000 V
- Average Rectified Output Current- 1 A
- High Surge Current Capability
- Designed for Surface Mount Application

MECHANICAL DATA

- Case: UMB
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 45mg 0.0016oz

PINNING

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)



UMB Package

Maximum Ratings and Electrical characteristics

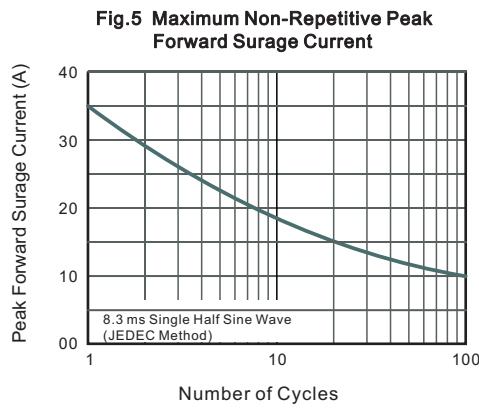
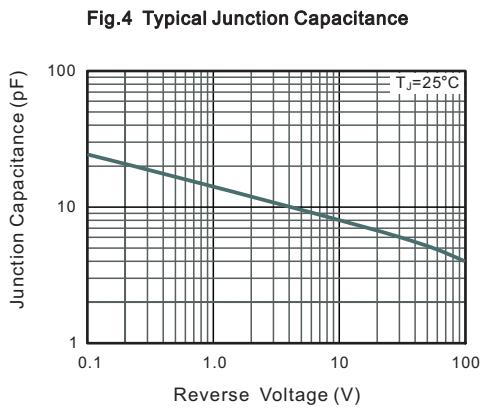
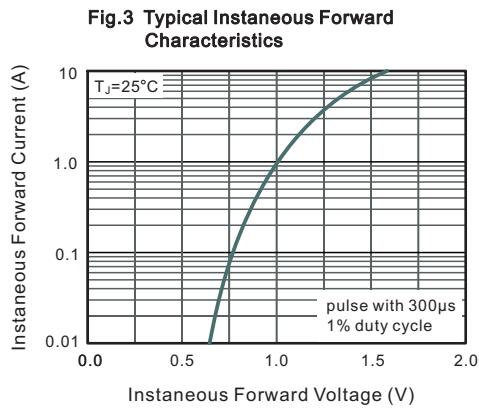
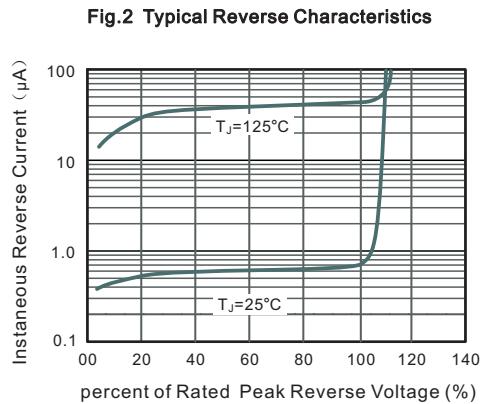
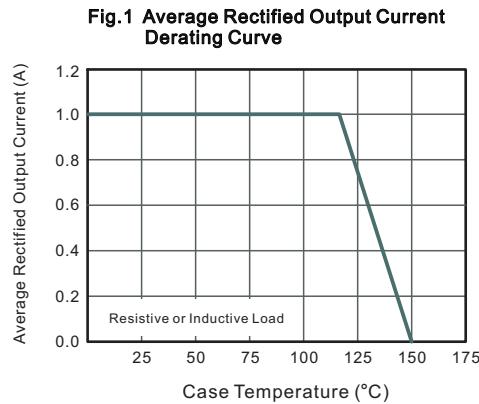
Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	LUM1B	LUM2B	LUM4B	LUM6B	LUM8B	LUM10B	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	100	200	400	600	800	1000	V
Average Rectified Output Current at T _c = 115 °C	I _o	1						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	35						A
Maximum Forward Voltage at 1.0 A	V _F	1.1						V
Maximum DC Reverse Current @T _a =25 °C at Rated DC Blocking Voltage @T _a =125 °C	I _R	5 40						µA
Typical Junction Capacitance (Note1)	C _j	13						pF
Typical Thermal Resistance (Note2)	R _{θJA} R _{θJC}	85 25						°C/W
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150						°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

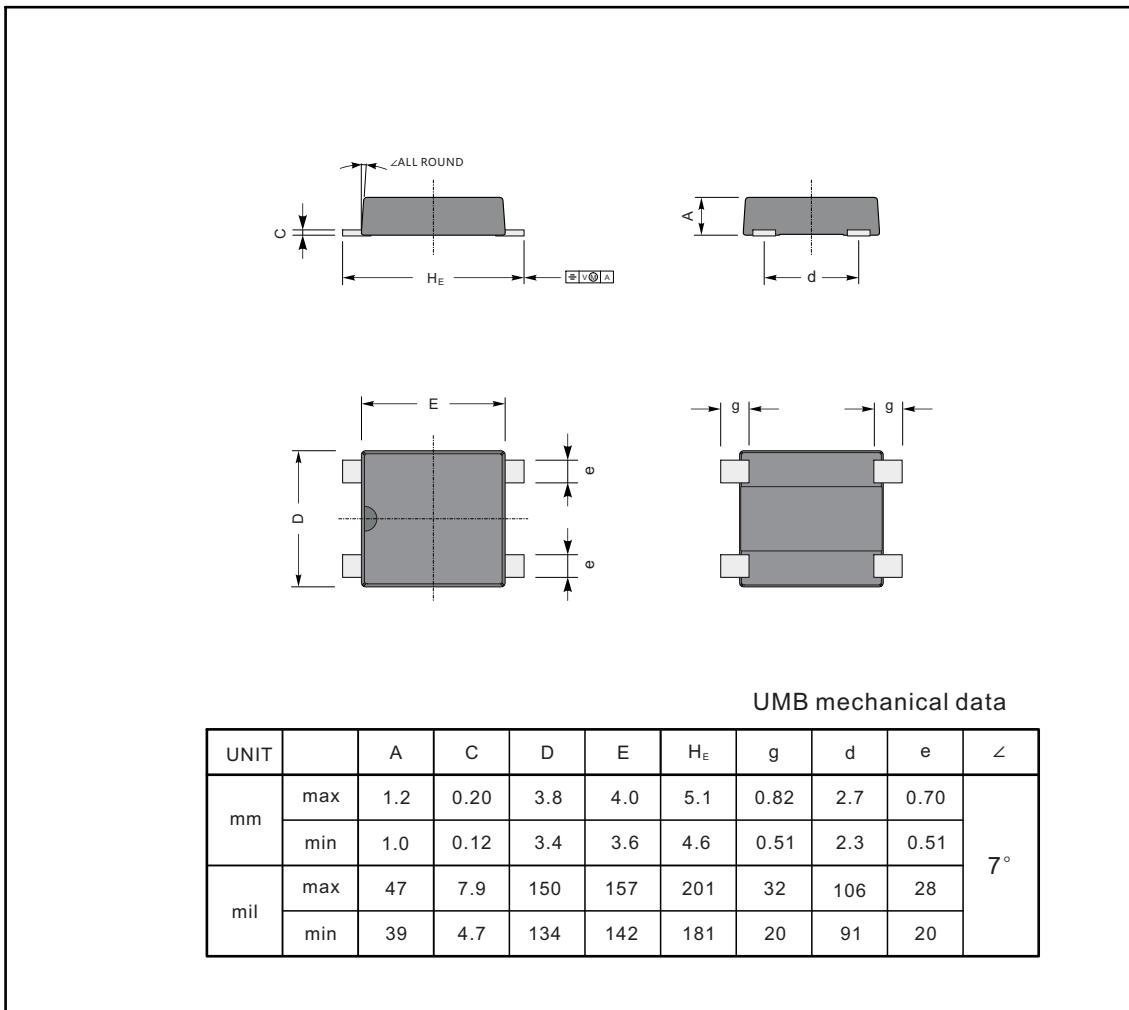
2. P.C.B. mounted with 4×1.5"×1.5" (3.81×3.81 cm) copper pad areas.



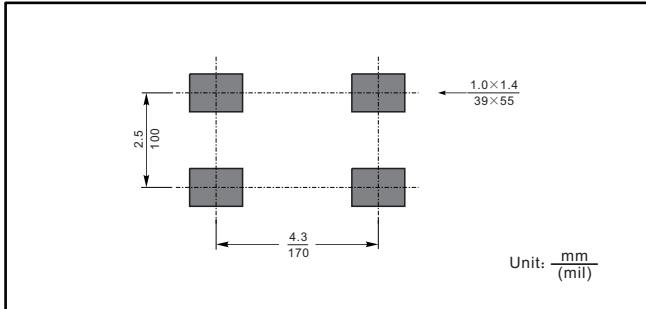
PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

UMB



The recommended mounting pad size



Marking

Type number	Marking code
LUM1B	10U1
LUM2B	10U2
LUM4B	10U4
LUM6B	10U6
LUM8B	10U8
LUM10B	10U10